

Docket No. END920020084US2
(EN-10-5695-D1)

APPLICATION DATA SHEET

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ASSIGNEE RESIDENCE::	Armonk, New York

CORRESPONDENCE INFORMATION::

Correspondence Customer Number:: 000026681

APPLICATION INFORMATION::

Title Line One:: SEMICONDUCTOR CHIP MODULE AND METHOD
Title Line Two:: OF MANUFACTURE OF SAME
Total Drawing Sheets:: 3
Formal Drawings?:: Yes
Application Type:: Utility
Docket Number:: END920020084US2 (IEN-10-5695-D1)

REPRESENTATIVE INFORMATION::

Representative Customer Number:: 000026681

CONTINUITY INFORMATION::

This application is a:: Divisional of
> Application One:: 10/254,414
Filing Date:: September 25, 2002
Patent Number::

PRIOR FOREIGN APPLICATIONS::

Foreign Application One:: No
Filing Date::
Country::
Priority Claimed::